

MPW #	Geometry	Reservation Close Date*	CDRS Submit Date@	Cancellation Deadline	Dry Run DRC CutOff	Other Participants Tapeout Date#&	Customer Tapeout Date#			Process Offering
MPW0695	55nm	4/27/2020	5/4/2020	5/26/2020	6/8/2020	6/8/2020	6/22/2020			55LPX/55LPe/55ULP/55BCDL/55NVM
MPW1424	12nm	4/22/2020	4/29/2020	5/21/2020	6/3/2020	6/10/2020	6/17/2020			12LP
MPW18G0	0.18um	4/20/2020	4/27/2020	5/19/2020	6/1/2020	6/1/2020	6/15/2020			Fab35_IC/BCDlite/UHV/MCU
MPW1508	0.15um	4/13/2020	4/20/2020	5/12/2020	5/25/2020	5/25/2020	6/8/2020			F35_MCU
MPW2234	22nm	3/16/2020	3/23/2020	4/14/2020	4/27/2020	4/27/2020	5/11/2020			22FDX
MPW0463	40nm	3/16/2020	3/23/2020	4/14/2020	4/27/2020	4/27/2020	5/11/2020			40LP/40HV/40NVM
MPW13B0	0.11/0.13um	3/16/2020	3/23/2020	4/14/2020	4/27/2020	4/27/2020	5/11/2020			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW0694	55nm	2/24/2020	3/2/2020	3/24/2020	4/6/2020	4/6/2020	4/20/2020			55LPX/55LPe/55ULP/55BCDL/55HV
MPW0359	28nm	2/17/2020	2/24/2020	3/17/2020	3/30/2020	3/30/2020	4/13/2020			28SLP/28SLPe/28SLP-RF/28SLP-HV
MPW0693	65nm	1/27/2020	2/3/2020	2/25/2020	3/9/2020	3/9/2020	3/23/2020			65G/65LPE

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MPW18F9	0.18um	1/27/2020	2/3/2020	2/25/2020	3/9/2020	3/9/2020	3/23/2020			Fab35_IC/BCDlite/UHV/MCU
MPW1423	12nm	1/22/2020	1/29/2020	2/20/2020	3/4/2020	3/11/2020	3/18/2020			12LP
MPW13A9	0.11/0.13um	1/13/2020	1/20/2020	2/10/2020	2/24/2020	2/24/2020	3/9/2020			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW2233	22nm	1/6/2020	1/13/2020	2/4/2020	2/17/2020	2/17/2020	3/2/2020			22FDX/22eMRAM. Projected ship dates are for NON-22eMRAM.
MPW1507	0.15um	12/23/2019	12/30/2019	1/21/2020	2/3/2020	2/3/2020	2/17/2020			F35_MCU
MPW0692	55nm	12/23/2019	12/30/2019	1/21/2020	2/3/2020	2/3/2020	2/17/2020			55LPX/55LPe/55ULP/55BCDL/55NVM
MPW0462	40nm	12/16/2019	12/23/2019	1/14/2020	1/27/2020	1/27/2020	2/10/2020			40LP/40NVM
MPW13A8	0.11/0.13um	11/18/2019	11/25/2019	12/17/2019	12/30/2019	12/30/2019	1/13/2020			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW2232	22nm	11/18/2019	11/25/2019	12/17/2019	12/30/2019	12/30/2019	1/13/2020			22FDX
MPW0358	28nm	11/11/2019	11/18/2019	12/10/2019	12/23/2019	12/23/2019	1/6/2020			28SLP/28SLPe/28SLP-RF/28SLP-HV

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MPW2231	22nm	10/17/2019	10/24/2019	11/14/2019	11/28/2019	11/28/2019	12/12/2019			22FDX/22eMRAM. Projected ship dates are for NON-22eMRAM.
MPW1422	12nm	10/16/2019	10/23/2019	11/13/2019	12/4/2019	12/4/2019	12/11/2019			12LP
MPW0691	55nm	10/7/2019	10/14/2019	11/5/2019	11/18/2019	11/18/2019	12/2/2019			55LPX/55LPe/55ULP/55BCDL/55NVM
MPW18F8	0.18um	10/7/2019	10/14/2019	11/5/2019	11/18/2019	11/18/2019	12/2/2019			Fab35_IC/BCDlite/UHV/MCU
MPW0461	40nm	9/30/2019	10/7/2019	10/29/2019	11/11/2019	11/11/2019	11/25/2019			40LP/40HV/40NVM
MPW9H04	9HP_90nm	9/30/2019		10/29/2019	11/11/2019	11/11/2019	11/25/2019			9HP
MPW9W01	9WG_90nm	9/23/2019		10/22/2019	11/4/2019	11/4/2019	11/18/2019			9WG
MPW13A7	0.11/0.13um	9/16/2019	9/23/2019	10/15/2019	10/28/2019	10/28/2019	11/11/2019			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW4R03	45RFSOI_45nm	9/16/2019		10/15/2019	10/28/2019	10/28/2019	11/11/2019			45RF
MPW9W00	9WG_90nm	9/13/2019		9/13/2019	9/13/2019	9/13/2019	9/13/2019			9WG

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MPW4R0A	45RFSOI_45nm	9/4/2019		9/5/2019	9/4/2019	9/4/2019	9/18/2019			45RF
MPW8H01	8HP_0.13um	9/2/2019		9/30/2019	10/14/2019	10/14/2019	10/28/2019			8HP_0.13um
MPW1506	0.15um	8/26/2019	9/2/2019	9/24/2019	10/7/2019	10/7/2019	10/21/2019			F35_MCU
MPW0690	55nm	8/19/2019	8/26/2019	9/17/2019	9/30/2019	9/30/2019	10/14/2019			55LPX/55LPe/55ULP/55BCDL/55NVM
MPW0357	28nm	8/12/2019	8/19/2019	9/10/2019	9/23/2019	9/23/2019	10/7/2019			28SLP/28SLP-RF/28SLP-HV
MPW18FA	0.18um	8/12/2019	8/19/2019	9/10/2019	9/23/2019	9/23/2019	10/7/2019			Fab35_IC/BCDlite/UHV
MPW7W00	7WL_0.18um	8/12/2019		9/9/2019	9/23/2019	9/23/2019	10/7/2019			7WL_0.18um
MPW1421	12nm	7/31/2019	8/7/2019	8/29/2019	9/11/2019	9/11/2019	9/25/2019			12LP
MPW0689	65nm	7/22/2019	7/29/2019	8/20/2019	9/2/2019	9/2/2019	9/16/2019			65G/65LPE
MPW13A6	0.11/0.13um	7/15/2019	7/22/2019	8/13/2019	8/26/2019	8/26/2019	9/9/2019			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD

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MPW035D	28nm	7/15/2019	7/22/2019	8/13/2019	8/26/2019	8/26/2019	9/9/2019			28LPSe
MPW9H03	9HP_90nm	7/15/2019		8/6/2019	8/19/2019	8/19/2019	9/2/2019			9HP
MPW0460	40nm	7/8/2019	7/15/2019	8/6/2019	8/19/2019	8/19/2019	9/2/2019			40LP/40NVM
MPW2230	22nm	7/8/2019	7/15/2019	8/6/2019	8/19/2019	8/19/2019	9/2/2019			22FDX
MPW8H00	8HP_0.13um	7/2/2019		7/31/2019	8/13/2019	8/13/2019	8/27/2019			8HP_0.13um
MPW4R02	45RFSOI_45nm	6/24/2019		7/23/2019	8/5/2019	8/5/2019	8/19/2019			45RF
MPW18F6	0.18um	6/17/2019	6/24/2019	7/16/2019	7/29/2019	7/29/2019	8/12/2019			Fab35_IC/BCDlite/UHV
MPW0688	55nm	6/17/2019	6/24/2019	7/15/2019	7/29/2019	7/29/2019	8/12/2019			55LPX/55LPe/55ULP/55BCDL/55HV
MPW4R01	45RFSOI_45nm	5/24/2019		5/25/2019	6/1/2019	6/1/2019	6/15/2019			45RF
MPW222A	22nm	5/20/2019	5/27/2019	6/17/2019	7/1/2019	7/1/2019	7/15/2019			22FDX

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MPW13A5	0.11/0.13um	5/13/2019	5/20/2019	6/11/2019	6/24/2019	6/24/2019	7/8/2019			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW0356	28nm	5/13/2019	5/20/2019	6/11/2019	6/24/2019	6/24/2019	7/8/2019			28SLP/28SLP-RF/28SLP-HV
MPW2229	22nm	5/6/2019	5/13/2019	6/4/2019	6/17/2019	6/17/2019	7/1/2019			22FDX/22eMRAM. Projected ship dates are for NON-22eMRAM.
MPW9H02	9HP_90nm	5/1/2019		5/14/2019	5/27/2019	5/27/2019	6/10/2019			9HP
MPW0687	55nm	4/22/2019	4/29/2019	5/21/2019	6/3/2019	6/3/2019	6/17/2019			55LPX/55LPe/55ULP/55BCDL/55NVM
MPW1420	12nm	4/8/2019	4/15/2019	5/7/2019	5/20/2019	5/20/2019	6/3/2019			12LP
MPW0459	40nm	4/8/2019	4/15/2019	5/7/2019	5/20/2019	5/20/2019	6/3/2019			40LP/40HV
MPW13A4	0.11/0.13um	3/18/2019	3/25/2019	4/16/2019	4/29/2019	4/29/2019	5/13/2019			RFSOI/G/LP/EEPROM/110TS/BCDlite/BCD
MPW9H01	9HP_90nm	3/4/2019		4/1/2019	4/15/2019	4/15/2019	4/29/2019			9HP

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